

## DATA SHEET

# SMP1340 Series: Fast Switching-Speed, Low-Capacitance, Plastic-Packaged PIN Diodes

## Applications

- Fast speed wireless switch applications

## Features

- Resistance: 0.85  $\Omega$  typical @ 10 mA
- Capacitance: 0.21 pF typical @ 5 V
- Packages rated MSL1, 260 °C per JEDEC J-STD-020



Skyworks Green™ products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green™*, document number SQ04-0074.








## Description

The SMP1340 series of plastic-packaged, surface-mountable PIN diodes is designed for high volume switch applications from 10 MHz to more than 10 GHz. The short carrier lifetime of 100 ns (typical), combined with their thin I-region width of 5  $\mu\text{m}$  (nominal) results in a group of fast speed RF switching PIN diodes.

The RF performance of the SMP1340 series is assured by virtue of their low capacitance (0.21 pF @ 5 V) and low resistance (0.85  $\Omega$  at 10 mA).

Table 1 describes the various packages and marking of the SMP1340 series.

Table 1. SMP1340 Series Packaging and Marking

					
Common Anode	Common Cathode		Single	Low Inductance	Single
SOT-23	SOT-23		SC-79 Green™	SOT-23 Green™	SOD-882 Green™
				<b>SMP1340-007LF</b> Marking: RSB	<b>SMP1340-040LF</b> Marking: D
<b>SMP1340-003LF</b> Green™ Marking: RS9	◆ <b>SMP1340-004LF</b> Green™ Marking: RS3		◆ <b>SMP1340-079LF</b> Marking: Cathode and CE		
$L_S = 1.5 \text{ nH}$	$L_S = 1.5 \text{ nH}$		$L_S = 0.7 \text{ nH}$	$L_S = 0.4 \text{ nH}$	$L_S = 0.45 \text{ nH}$



The Pb-free symbol or “LF” in the part number denotes a lead-free, RoHS-compliant package unless otherwise noted as Green™. Tin/lead (Sn/Pb) packaging is not recommended for new designs.

## Electrical and Mechanical Specifications

The absolute maximum ratings of the SMP1340 series are provided in Table 2. Electrical specifications are provided in Table 3. Resistance versus temperature measurements are provided in Table 4.

Typical performance characteristics of the SMP1340 series are illustrated in Figures 1 through 4. Package dimensions are shown in Figures 5 to 9 (odd numbers), and tape and reel dimensions are provided in Figures 6 to 10 (even numbers).

## Package and Handling Information

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SMP1340 series is rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

**Table 2. SMP1340 Series Absolute Maximum Ratings<sup>1</sup>**

Parameter	Symbol	Minimum	Maximum	Units
Reverse voltage	$V_R$		50	V
Power dissipation @ 25 °C lead temperature	$P_D$		400	mW
Storage temperature	$T_{STG}$	-65	+150	°C
Operating temperature	$T_A$	-65	+150	°C
Electrostatic discharge: Human Body Model (HBM), Class 1A	ESD		500	V

<sup>1</sup> Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

**ESD HANDLING:** Industry-standard ESD handling precautions must be adhered to at all times to avoid damage to this device.

**Table 3. SMP1340 Series Electrical Specifications<sup>1</sup>**

( $T_A = +25\text{ °C}$ , Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
Reverse current	$I_R$	$V_R = 50\text{ V}$			10	$\mu\text{A}$
Capacitance	$C_T$	$F = 1\text{ MHz}, V = 5\text{ V}$		0.21	0.30	pF
Resistance	$R_S$	$F = 100\text{ MHz}$				
		$I = 1\text{ mA}$		1.7		$\Omega$
		$I = 5\text{ mA}$		1.0	2.0	$\Omega$
		$I = 10\text{ mA}$		0.85	1.2	$\Omega$
Forward voltage	$V_F$	$I_F = 10\text{ mA}$		0.85		V
Carrier lifetime	$\tau_I$	$I_F = 10\text{ mA}$		100		ns
I region width				5		$\mu\text{m}$

<sup>1</sup> Performance is guaranteed only under the conditions listed in this table.

**Table 4. Resistance vs Temperature @ 500 MHz**

$I_F$ (mA)	$R_S$ @ -55 °C ( $\Omega$ )	$R_S$ @ -40 °C ( $\Omega$ )	$R_S$ @ -15 °C ( $\Omega$ )	$R_S$ @ +25 °C ( $\Omega$ )	$R_S$ @ +65 °C ( $\Omega$ )	$R_S$ @ +85 °C ( $\Omega$ )	$R_S$ @ +100 °C ( $\Omega$ )
0.02	9.92	9.68	9.30	8.95	8.95	9.01	9.12
0.10	3.90	3.86	3.79	3.80	3.85	3.94	4.03
0.30	2.32	2.33	2.30	2.33	2.35	2.43	2.49
0.50	1.91	1.93	1.90	1.92	1.92	1.99	2.05
1.0	1.54	1.55	1.52	1.53	1.50	1.56	1.61
10	0.95	0.96	0.91	0.90	0.82	0.85	0.89
20	0.86	0.87	0.82	0.81	0.73	0.75	0.79
100	0.72	0.73	0.70	0.68	0.59	0.62	0.65

Typical Performance Characteristics

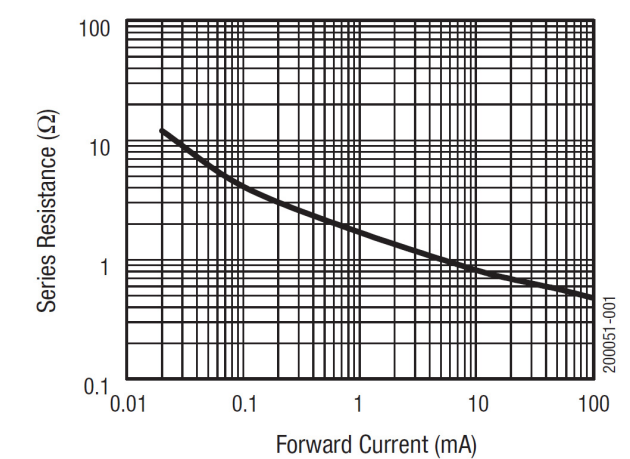


Figure 1. Series Resistance vs Current @ 100 MHz

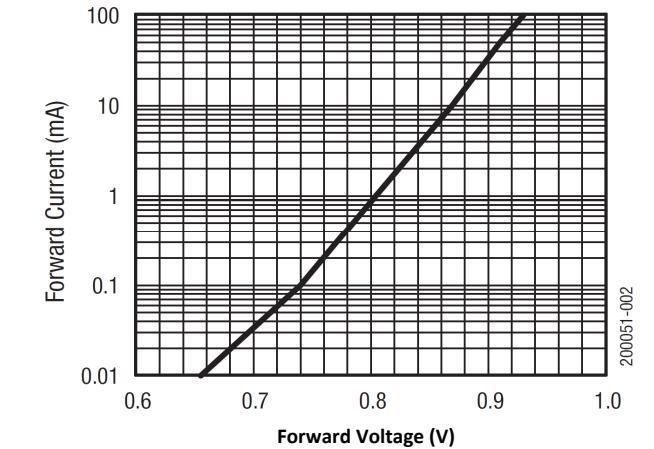


Figure 2. Forward Current vs Voltage

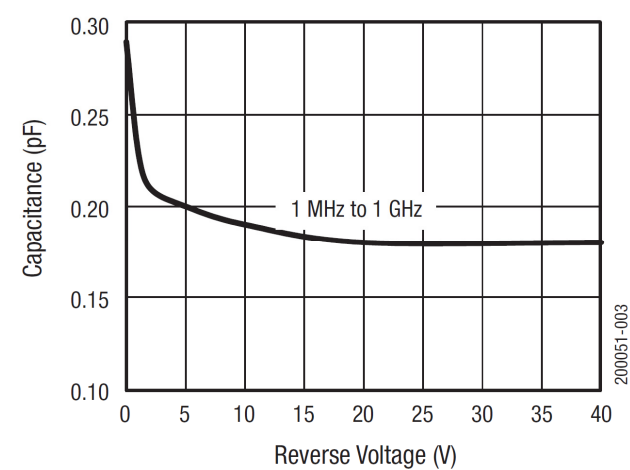


Figure 3. Capacitance vs Reverse Voltage

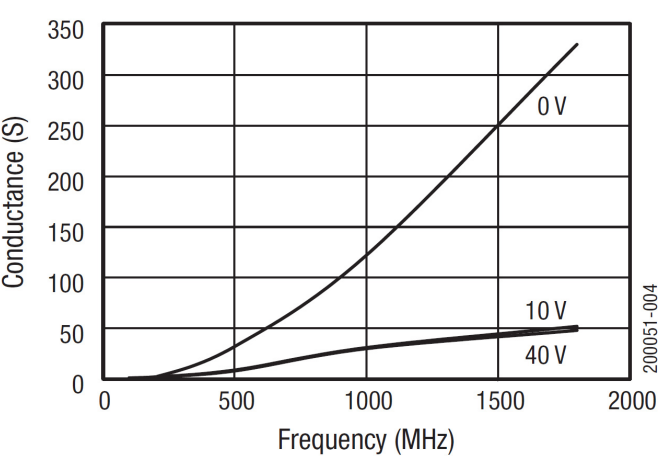


Figure 4. Conductance vs Frequency and Reverse Voltage

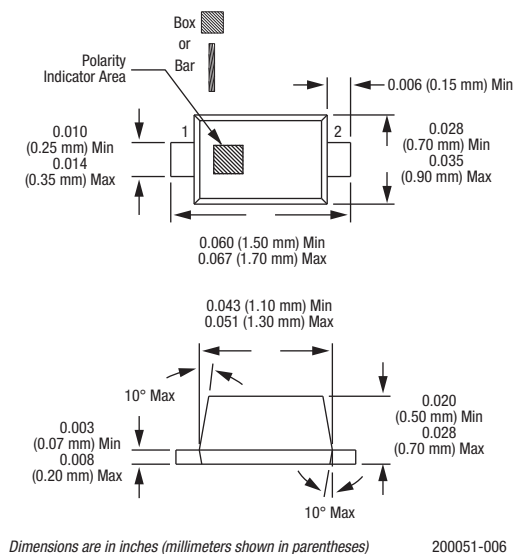
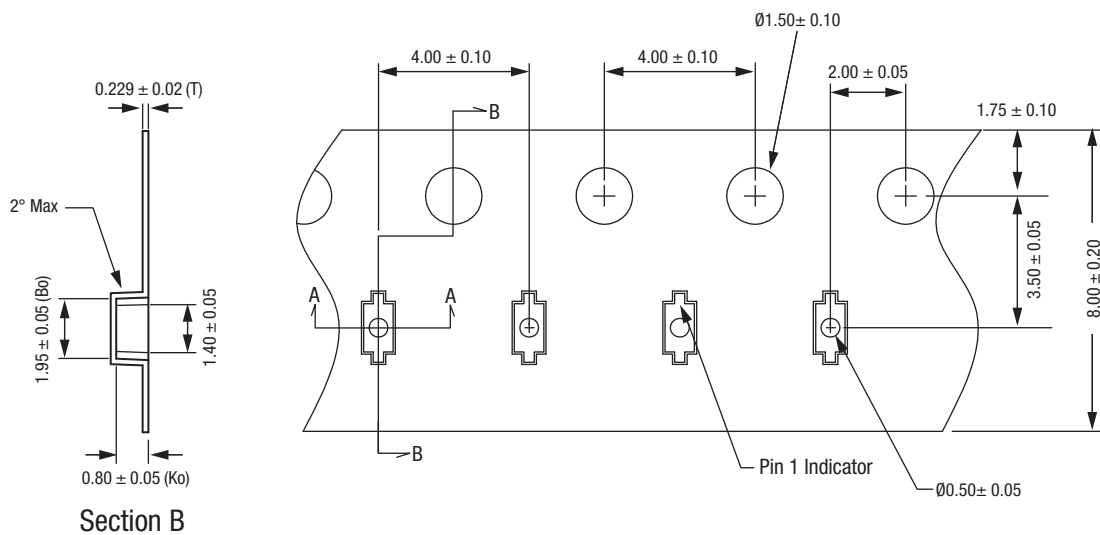


Figure 5. SC-79 Package Dimension Drawing



Notes:

1. Carrier tape: black conductive polycarbonate or polystyrene.
2. Cover tape material: transparent conductive PSA.
3. Cover tape size: 5.4 mm width.
4. ESD-surface resistivity is  $\leq 1 \times 10^8$  Ohms/square per EIA, JEDEC TNR Specification.
5. All measurements are in millimeters.

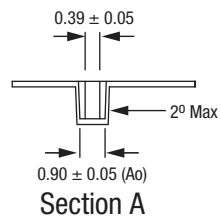
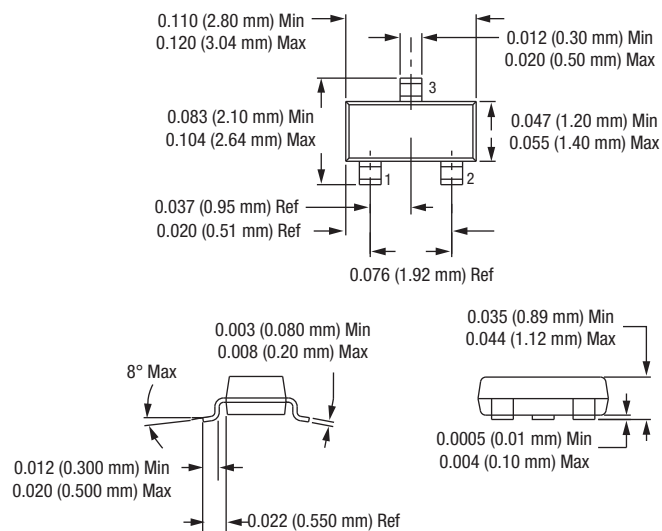


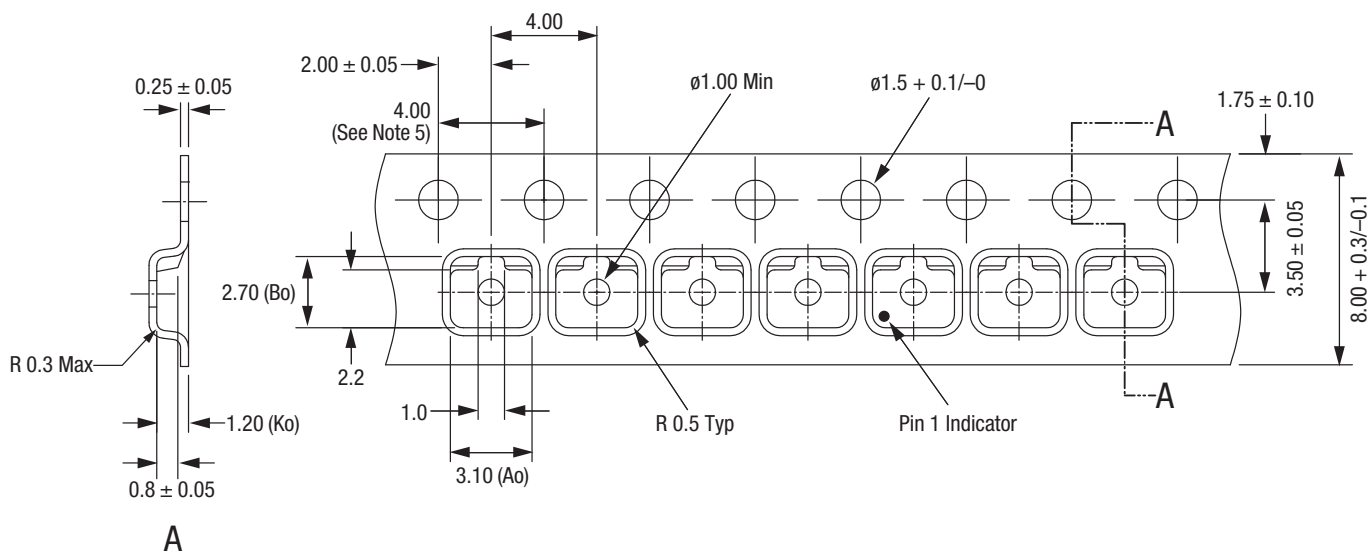
Figure 6. SC-79 Tape and Reel Dimensions



Dimensions are in inches (millimeters shown in parentheses)

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Figure 7. SOT-23 Package Dimension Drawing

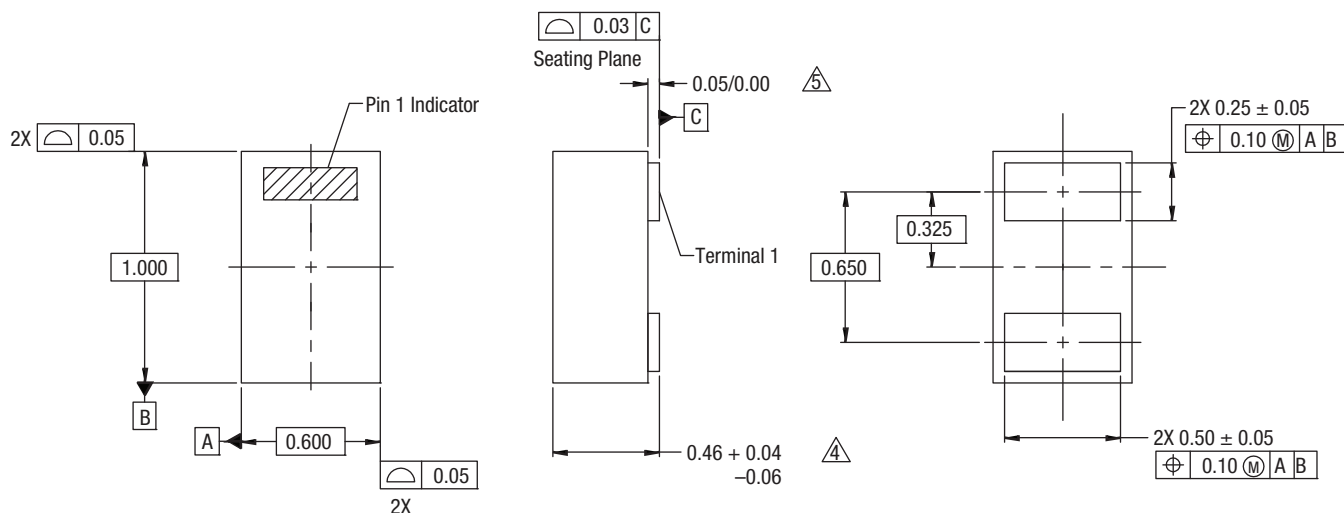


Notes:

1. Carrier tape: black conductive polycarbonate.
2. Cover tape material: transparent conductive PSA.
3. Cover tape size: 5.40 mm width.
4. Tolerance:  $\pm 0.10$  mm.
5. Ten sprocket hole pitch cumulative tolerance:  $\pm 0.2$  mm.
6. All measurements are in millimeters.
7. Alternative carrier tape dimensions are:  
 $A_o = 3.3$   
 $B_o = 2.9$   
 $K_o = 1.22$

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Figure 8. SOT-23 Tape and Reel Dimensions

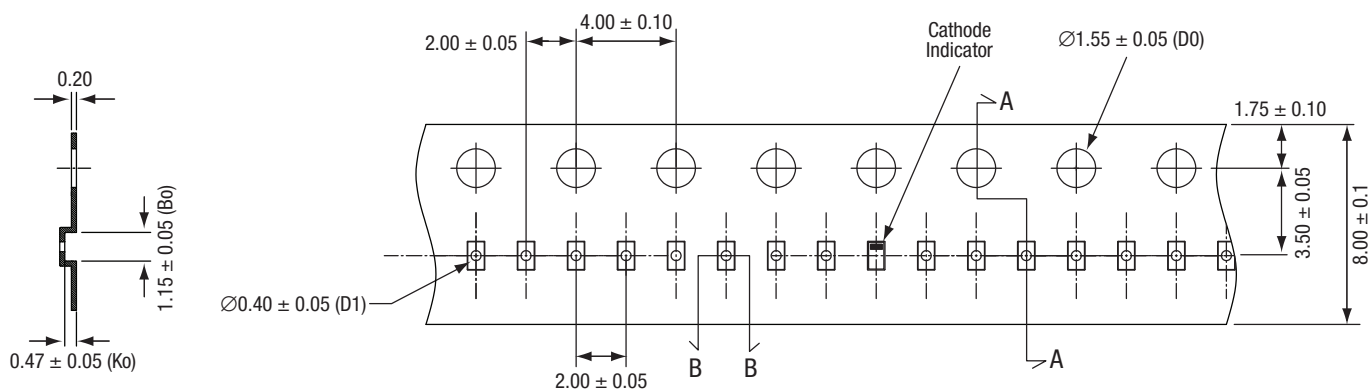


*Notes:*

1. All measurements are in millimeters.
2. Dimensions and tolerances according to ASME Y14.5M-1994.
3. These packages are used principally for discrete devices.
4. This dimension includes stand-off height and package body thickness, but does not include attached features, e.g., external heatsink or chip capacitors. An integral heatslug is not considered an attached feature.
5. This dimension is primarily terminal plating, but does not include small metal protrusion.

200051-009

**Figure 9. SOD-882 Package Dimension Drawing**



## Section A

 $0.70 \pm 0.05$  (A0)

## Section B

*Notes:*

1. Carrier tape: black conductive polycarbonate.
2. Cover tape: transparent conductive material.
3. Cover tape size: 5.4 mm width.
4. ESD surface resistivity is  $\geq 1 \times 10^4 \sim \leq 1 \times 10^8$  Ohms/square.
5. All dimensions are in millimeters.

200051-010

### Figure 10. SOD-882 Tape and Reel Dimensions

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